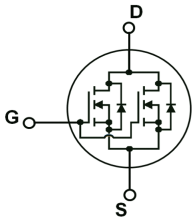
MOSFET – N-Channel, POWERTRENCH®

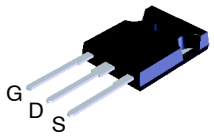
150 V, 167 A, 5.9 mΩ

FDH055N15A

V_{DS}	$R_{DS(on)}$ MAX	I_D MAX
150 V	5.9 mΩ @ 10 V	167 A



N-CHANNEL MOSFET



TO−247−3LD
CASE 340CK

Description

This N−Channel MOSFET is produced using **onsemi**'s advanced POWERTRENCH process that has been tailored to minimize the on−state resistance while maintaining superior switching performance.

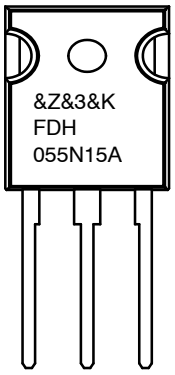
Features

- $R_{DS(on)}$ = 4.8 mΩ (Typ.) @ V_{GS} = 10 V, I_D = 120 A
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low $R_{DS(on)}$
- High Power and Current Handling Capability
- This Device is Pb−Free and is RoHS Compliant

Applications

- Synchronous Rectification for ATX / Sever / Telecom PSU
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies
- Micro Solar Inverter

MARKING DIAGRAM



&Z	= Assembly Plant Code
&3	= Numeric Date Code
&K	= Lot Code
FDH055N15A	= Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

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ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Symbol	Parameter		FDH055N15A	Unit
V_{DSS}	Drain to Source Voltage		150	V
V_{GSS}	Gate to Source Voltage	– DC	±20	V
		– AC (f > 1 Hz)	±30	
I_D	Drain Current	– Continuous (T_C = 25°C, Silicon Limited)	167 (Note 1)	A
		– Continuous (T_C = 100°C, Silicon Limited)	118	
		– Continuous (T_C = 25°C, Package Limited)	156	
I_{DM}	Drain Current	– Pulsed (Note 2)	668	A
E_{AS}	Single Pulsed Avalanche Energy (Note 3)		835	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 4)		6.0	V/ns
P_D	Power Dissipation	(T_C = 25°C)	429	W
		– Derate above 25°C	2.86	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range		–55 to + 175	°C
T_L	Maximum Lead Temperature for Soldering, 1/8″ from Case for 5 Second		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Calculated continuous current based on maximum allowable junction temperature, Package limitation current is 156 A.
2. Repetitive Rating: Pulse width limited by maximum junction temperature.
3. Starting T_J = 25°C, L = 3 mH, I_{AS} = 23.6 A
4. I_{SD} ≤ 120 A, di/dt ≤ 200 A/s, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C.

THERMAL CHARACTERISTICS

Symbol	Parameter	FDH055N15A	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.35	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Package Method	Reel Size	Tape Width	Quantity
FDH055N15A	FDH055N15A	TO−247−3LD	Tube	N/A	N/A	30 Units

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
OFF CHARACTERISTICS						
BV_{DSS}	Drain to Source Breakdown Voltage	I_D = 250 μA, V_{GS} = 0 V	150	–	–	V
ΔBV_{DSS} / ΔT_J	Breakdown Voltage Temperature Coefficient	I_D = 250 μA, Referenced to 25°C	–	0.1	–	V/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 120 V, V_{GS} = 0 V	–	–	1	μA
		V_{DS} = 120 V, T_C = 150°C	–	–	500	
I_{GSS}	Gate to Body Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V	–	–	±100	nA
ON CHARACTERISTICS						
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 250 μA	2.0	–	4.0	V
$R_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = 10 V, I_D = 120 A	–	4.8	5.9	mΩ
g_{FS}	Forward Transconductance	V_{DS} = 10 V, I_D = 120 A	–	219	–	S
DYNAMIC CHARACTERISTICS						
C_{iss}	Input Capacitance	V_{DS} = 75 V, V_{GS} = 0 V, f = 1 MHz	–	7100	9445	pF
C_{oss}	Output Capacitance		–	664	885	pF
C_{rss}	Reverse Transfer Capacitance		–	23	35	pF
$C_{oss(er)}$	Energy Related Output Capacitance	V_{DS} = 75 V, V_{GS} = 0 V	–	1159	–	pF
$Q_{g(tot)}$	Total Gate Charge at 10 V	V_{DS} = 75 V, I_D = 120 A, V_{GS} = 10 V (Note 5)	–	92	–	nC
Q_{gs}	Gate to Source Gate Charge		–	31	–	nC
Q_{gs2}	Gate Charge Threshold to Plateau		–	15	–	nC
Q_{gd}	Gate to Drain “Miller” Charge		–	16	–	nC
ESR	Equivalent Series Resistance(G−S)	f = 1 MHz	–	1.2	–	Ω
SWITCHING CHARACTERISTICS						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 75 V, I_D = 120 A, V_{GS} = 10 V, R_G = 4.7 Ω (Note 5)	–	35	80	ns
t_r	Turn−On Rise Time		–	67	144	ns
$t_{d(off)}$	Turn-Off Delay Time		–	71	152	ns
t_f	Turn−Off Fall Time		–	21	52	ns
DRAIN-SOURCE DIODE CHARACTERISTICS						
I_S	Maximum Continuous Drain to Source Diode Forward Current		–	–	167 (Note 1)	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		–	–	668	A
V_{SD}	Drain to Source Diode Forward Voltage	V_{GS} = 0 V, I_{SD} = 120 A	–	–	1.25	V
t_{rr}	Reverse Recovery Time	V_{GS} = 0 V, I_{SD} = 120 A, V_{DS} = 75 V, dI_F/dt = 100 A/μs	–	105	–	ns
Q_{rr}	Reverse Recovery Charge		–	342	–	nC
Q_{rr}	Reverse Recovery Charge	V_{GS} = 0 V, I_{SD} = 30 A, V_{DS} = 75 V, dI_F/dt = 100 A/μs	–	348	–	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

5. Essentially Independent of Operating Temperature Typical Characteristics.

TYPICAL CHARACTERISTICS

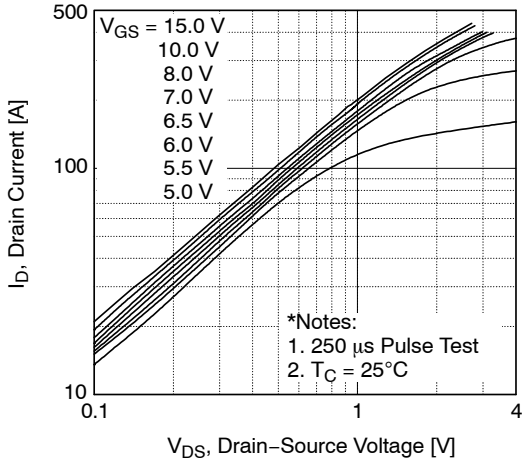


Figure 1. On−Region Characteristics

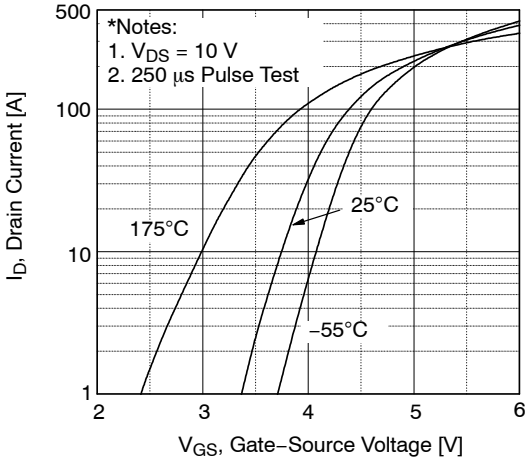


Figure 2. Transfer Characteristics

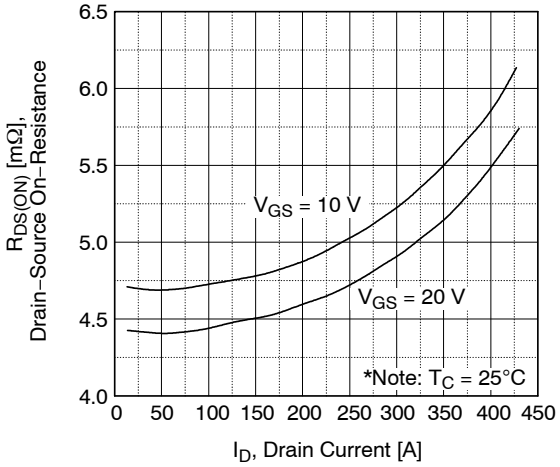


Figure 3. On−Resistance Variation vs. Drain Current and Gate Voltage

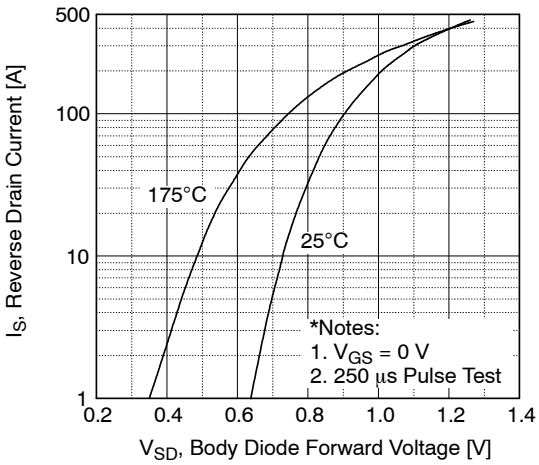


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

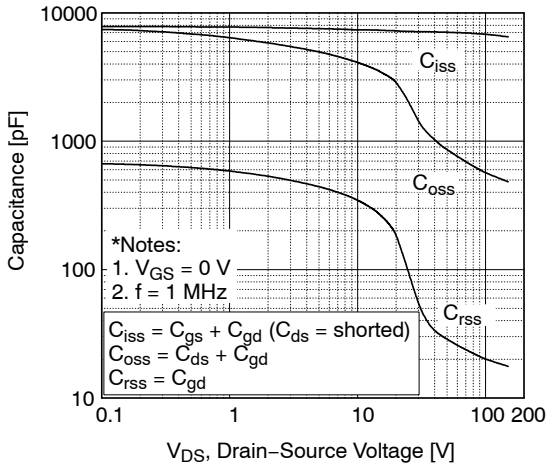


Figure 5. Capacitance Characteristics

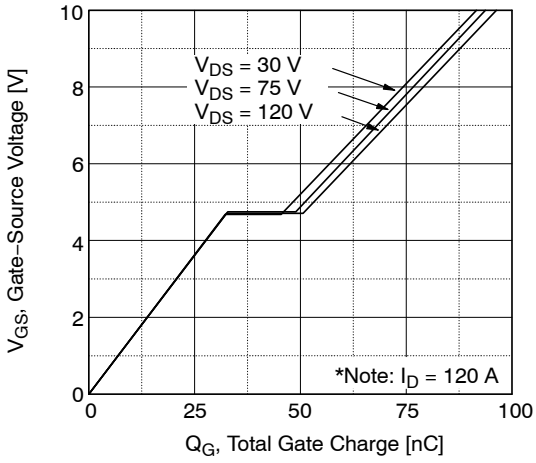


Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS (continued)

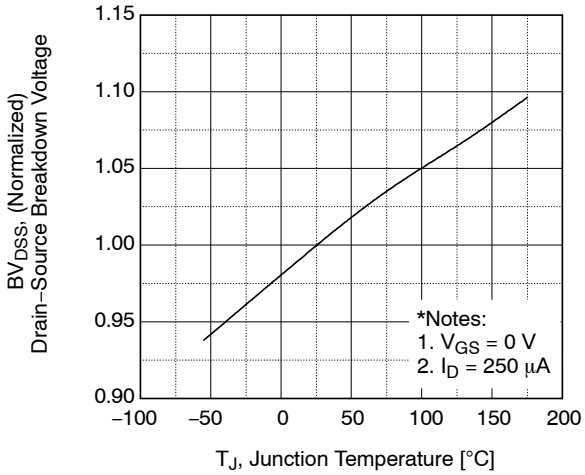


Figure 7. Breakdown Voltage Variation vs. Temperature

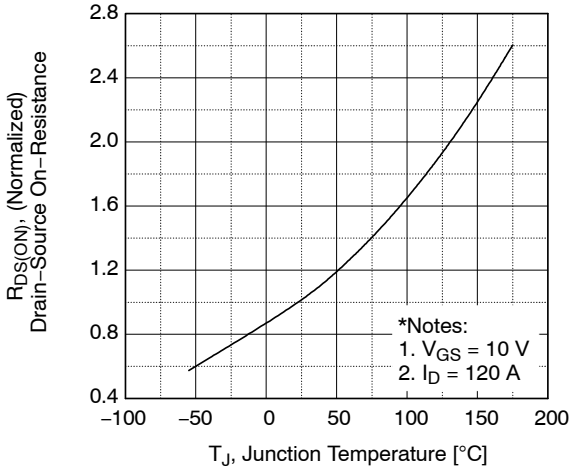


Figure 8. On−Resistance Variation vs. Temperature

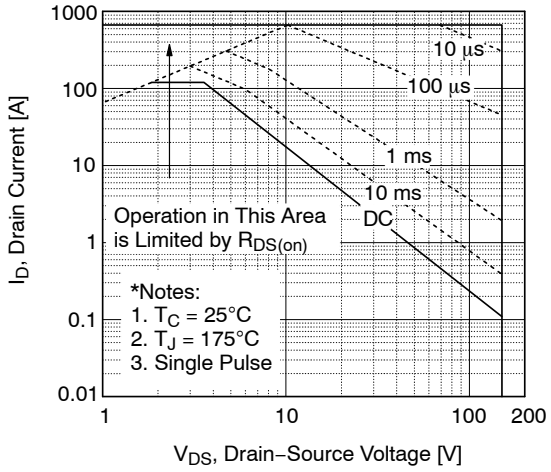


Figure 9. Maximum Safe Operating Area

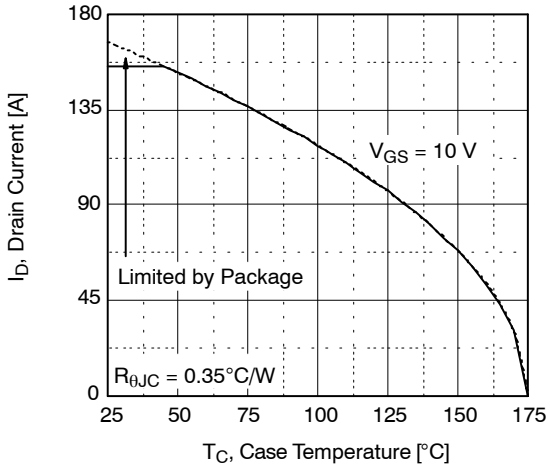


Figure 10. Maximum Drain Current vs. Case Temperature

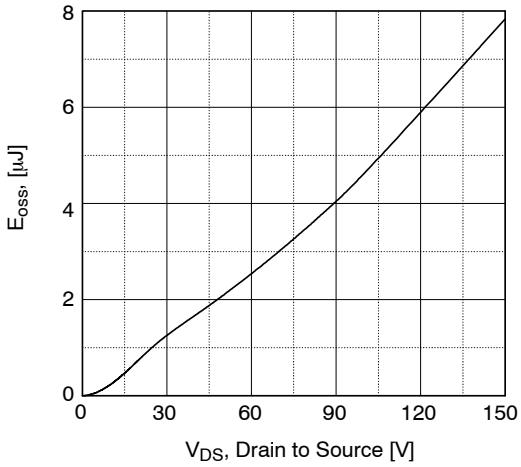


Figure 11. Eoss vs. Drain to Source Voltage

TYPICAL CHARACTERISTICS (continued)

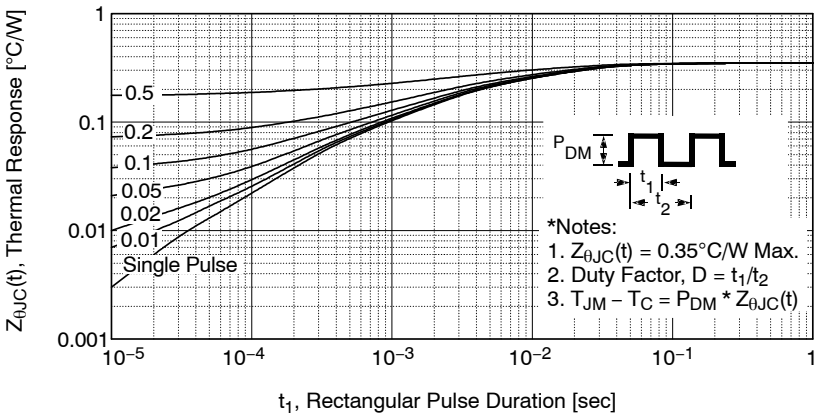


Figure 12. Transient Thermal Response Curve

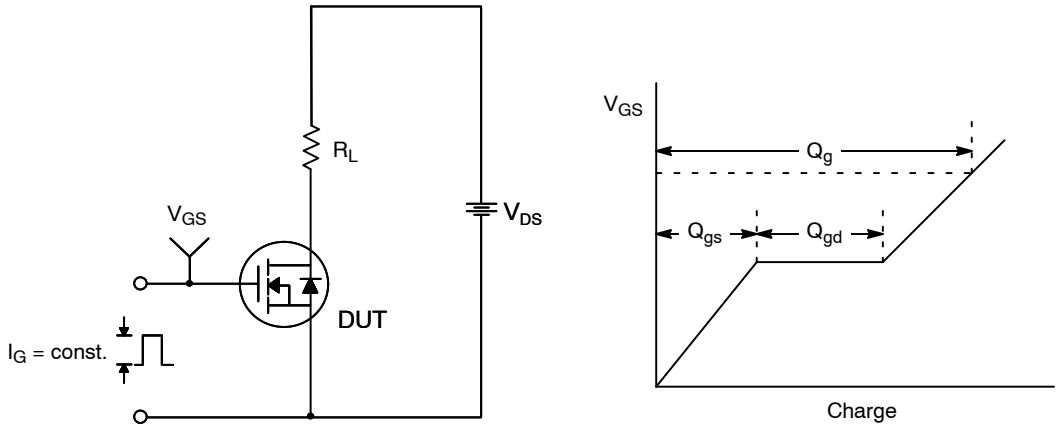


Figure 13. Gate Charge Test Circuit & Waveform

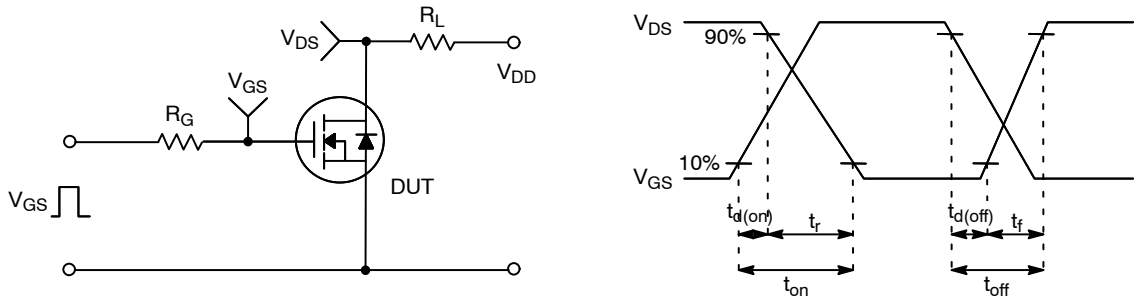


Figure 14. Resistive Switching Test Circuit & Waveforms

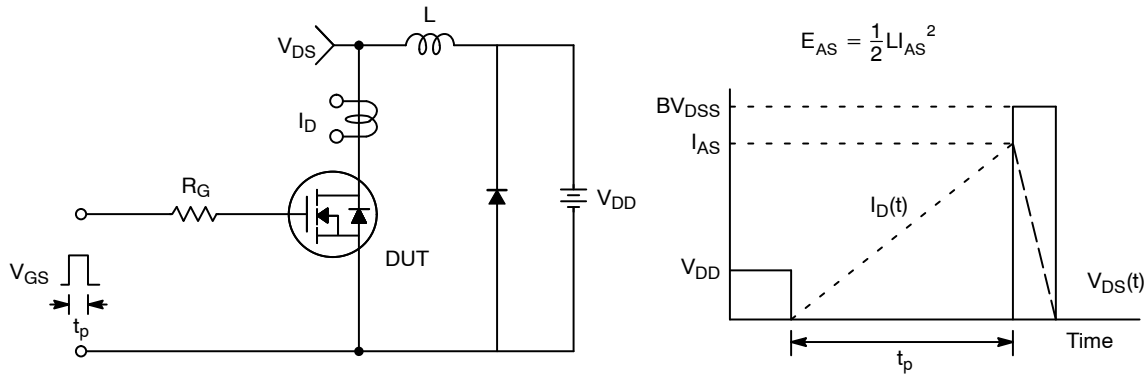


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

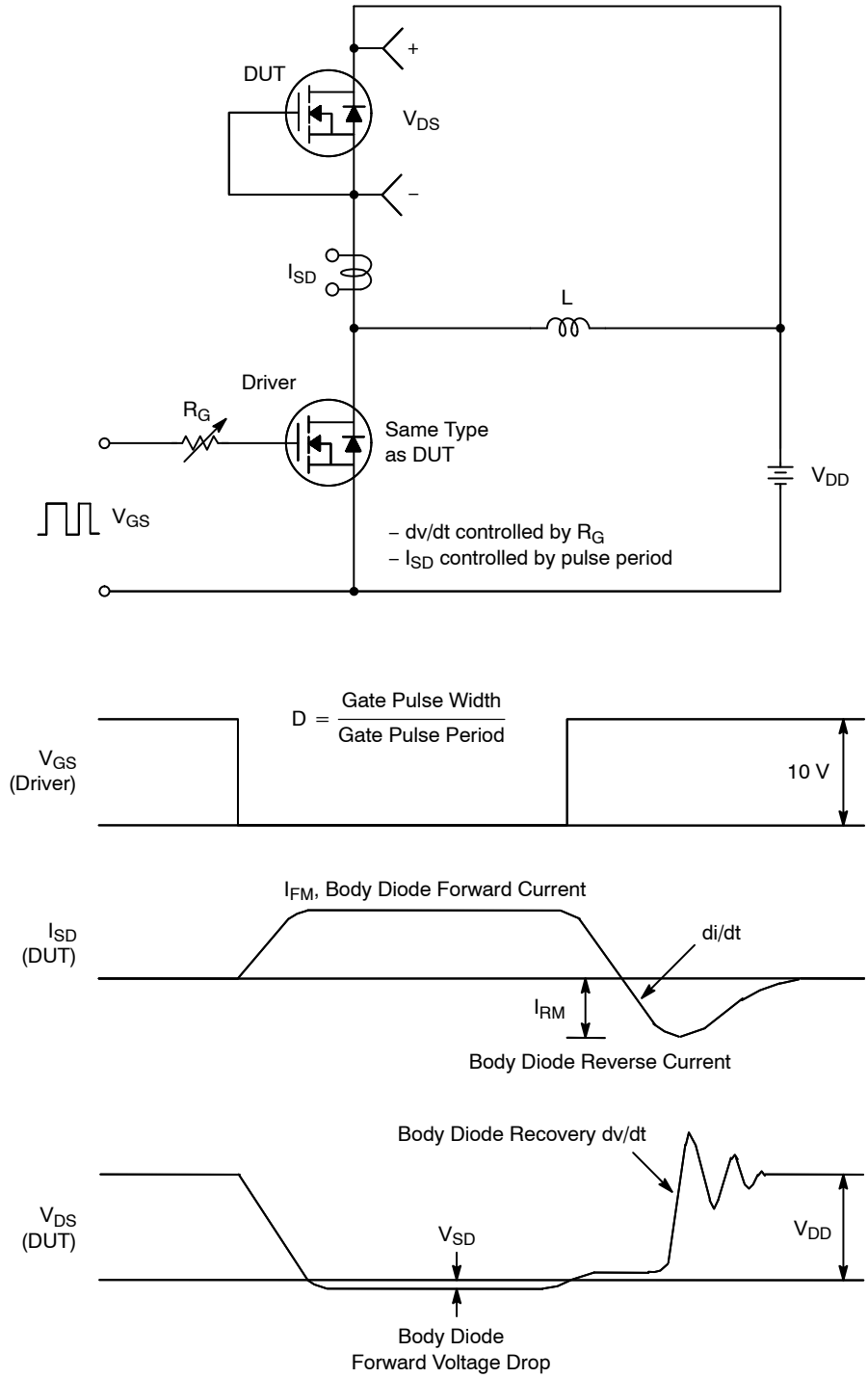
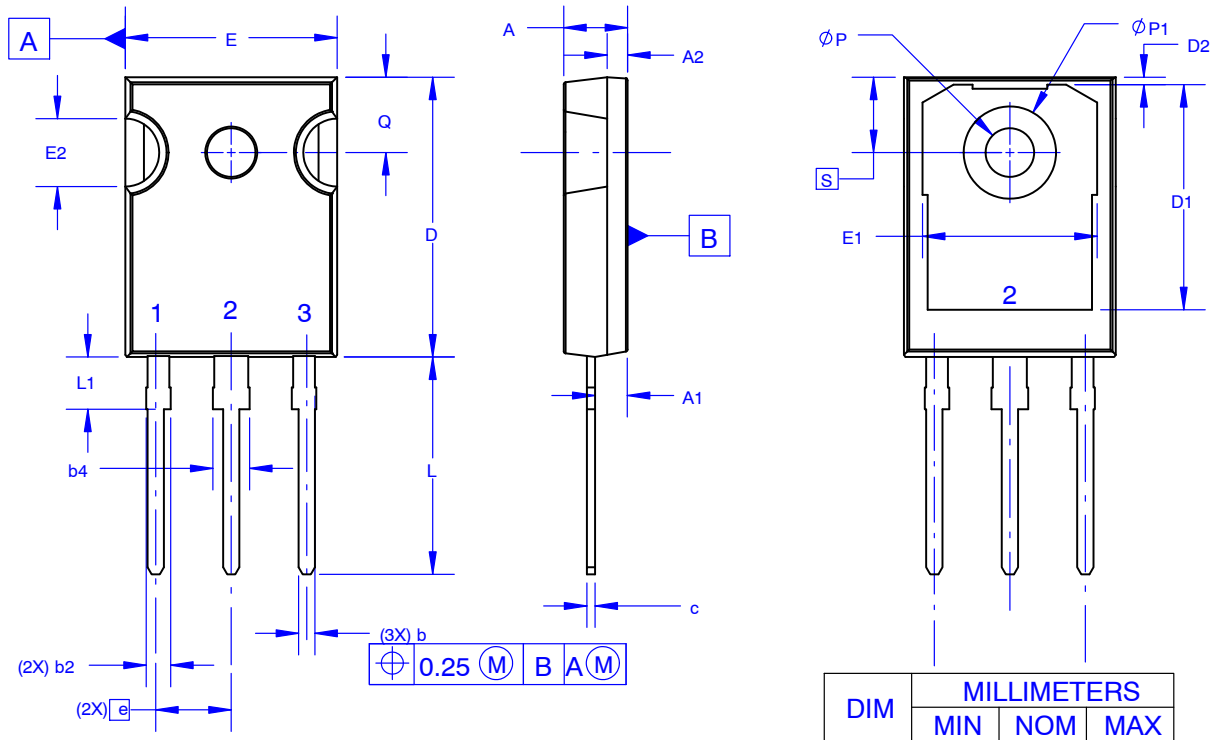


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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TO−247−3LD SHORT LEAD
CASE 340CK
ISSUE A

DATE 31 JAN 2019

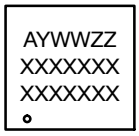


DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.58	4.70	4.82
A1	2.20	2.40	2.60
A2	1.40	1.50	1.60
b	1.17	1.26	1.35
b2	1.53	1.65	1.77
b4	2.42	2.54	2.66
c	0.51	0.61	0.71
D	20.32	20.57	20.82
D1	13.08	~	~
D2	0.51	0.93	1.35
E	15.37	15.62	15.87
E1	12.81	~	~
E2	4.96	5.08	5.20
e	~	5.56	~
L	15.75	16.00	16.25
L1	3.69	3.81	3.93
ØP	3.51	3.58	3.65
ØP1	6.60	6.80	7.00
Q	5.34	5.46	5.58
S	5.34	5.46	5.58

NOTES: UNLESS OTHERWISE SPECIFIED.

A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
B. ALL DIMENSIONS ARE IN MILLIMETERS.
C. DRAWING CONFORMS TO ASME Y14.5 - 2009.
D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.

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Üretici parça numarasını yazın; stok ve fiyatı hemen görün.

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Kategorilere göz atın

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Teklif isteyin

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